FORM PTO-1584 01-10-96:CMG Atty Ref/Docket No.: 303.572US1

Box Assignments Washington, D.C. 20231

03-05-1999

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U.S. DEPARTMENT	OF COMMERCE
Patent and	Trademark Office

100977908 r copy thereof. To the Honorable Commissioner of Patents and Trac 2. Name and address of receiving party(ies): i. Name of conveying party(ics): Paul A. Parrar Name: Micron Technology, Inc. Additional name(s) of conveying party(les) attached? [ ]Yes [X]No Street Address: 8000 South Federal Way 3. Nature of conveyance: [] Merger [X] Assignment State: ID ZIP: 83716-9632 [] Change of Name [] Security Agreement [ ] Other \_\_\_ Additional name(s) & address(es) attached? [ ]Yes [X]No Execution Date: <u>Rebruary 16, 1999</u> 4. Application number(s) or patent number(s): B. Patent No.(s) A. Patent Application No.(s) Additional numbers attached? [ ]Yes [X]No 5. Name and address of party to whom correspondence concerning document should be mailed: 6. Total number of applications and patents involved: 7. Total fee (37 CFR 3.41):\$\_40.00 Name: Thomas W. Leffert (X) Enclosed Address: Schwegman, Lundberg, Woessner & Kluth, P.A. [] Authorized to be charged to deposit account P.O. Box 2938 Minneapolis, MN 55402 8. Please charge any additional fees or credit any overpayments to our Deposit account number: \_\_\_\_19-0743 DO NOT USE THIS SPACE 9. Statement and signature. py is a true copy of the original docu To the best of my knowledge and belief, the foregoing inform Thomas W. Leffert/Reg. No. 40.697 Name of Person Signing Total number of pages including cover sheet: 3 OMB No. 0651-0011 (exp. 4/94) 03/04/1999 BHRINEN 00000072 09P53611 Do not detach this portion 40.00 01 FC:581 Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks

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**PATENT REEL: 9792 FRAME: 0791** 

## ASSIGNMENT



WHEREAS, I. Paul A. Farrar, residing at 17 Yandow Drive, So. Burlington. VT 05403, made certain new and useful inventions and improvements for which I executed an application for Letters Patent of the United States on Even Date Herewith, which is entitled SELECTIVE DEPOSITION OF SOLDER BALL CONTACTS.

AND WHEREAS, Micron Technology. Inc., a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 8000 South Federal Way, Boise. ID 83716-9632, (hereinafter "Assignee") is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefor;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, I have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted therefrom; and I do hereby authorize and request the Commissioner of Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, I do hereby agree that I and my executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

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AND, furthermore I covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by me and that full right to convey the same as herein expressed is possessed by me.

Farrar to me known and known to me to be the person described in and who executed the foregoing instrument, and he/she duly acknowledged to me that he/she executed the same for the uses and purposes therein set forth.

[SEAL]

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**RECORDED: 02/19/1999**